

BODMRUN[®]

SUPHIP[®] 灼克

浙江葆润应用材料有限公司

材料创新赋能热失控安全
Material Innovation Empowers Thermal Runaway Safety



“ SUPHIP ®Introduction

BOOMRUN SUPHIP ® The series of inorganic fiber nanocomposite insulation materials, as an innovative thermal barrier material, mainly consists of ultra-fine porous nano insulation powder. It uses special inorganic fibers as carriers and is designed with a special formula to isolate heat in three dimensions: heat conduction, radiation, and convection. The thermal conductivity is low at high temperatures. When the battery cell loses control, it can greatly block the diffusion of insulation, providing a cost-effective solution for power and energy storage batteries with a full lifecycle thermal runaway material.

Low thermal conductivity
Excellent thermal conductivity performance at high temperatures

Excellent fire resistance, with a flame penetration time of over 10 minutes at 1000 °C

The product meets RoHS, REACH, and ELV directives

Low cost
High cost performance ratio





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SUPHIP® Production process



Mixing

Initial formula preparation



Molding

Water filtration forms sheets



Drying

Core sheet material Drying



Cutting

Cutting machine cuts the core body



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SUPHIP® 灼克® Application scenarios



- Protection against thermal spread between power battery cells of electric vehicles
- Thermal protection and insulation between energy storage battery cells and modules
- Thermal Protection of Aerospace Shuttle Power Systems

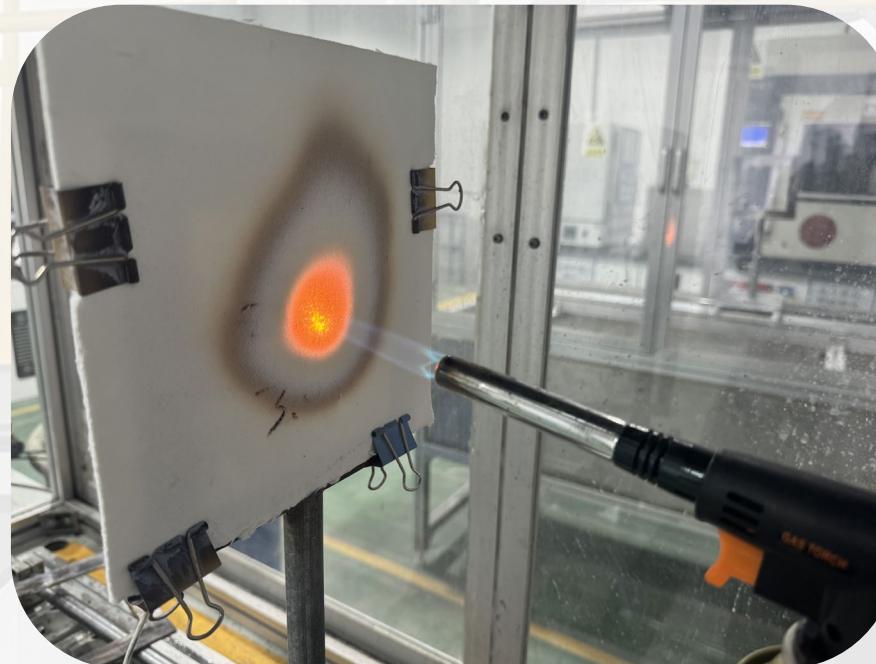
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SUPHIP—ZK01 Performance parameter table of core material

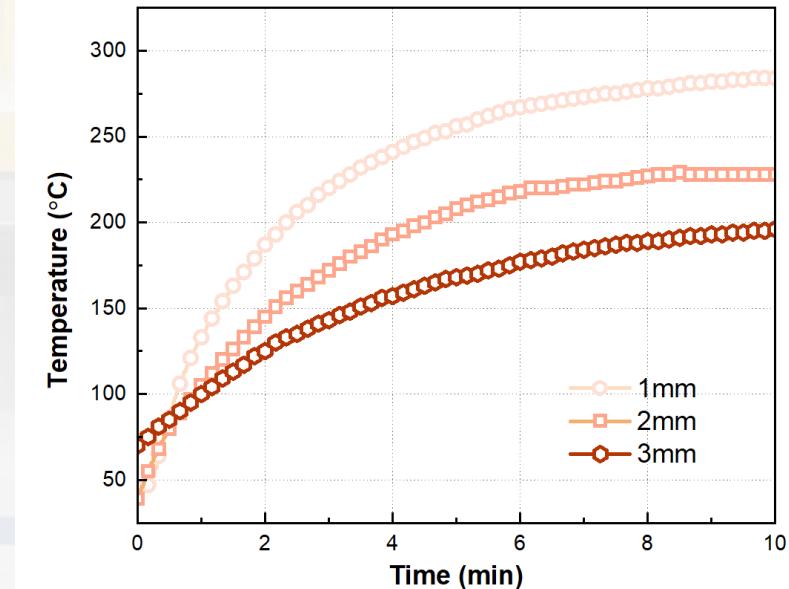
| Characteristic | Unit | Typical value | Remarks (Testing Standards and Methods) |
|---|-------------------|----------------|--|
| Physical Characteristics | | | |
| Thickness | mm | 0.5-1.5 | Thickness tolerance±0.1mm |
| Density | kg/m ³ | 200-360 | GB/T 17911-2018 |
| Compression performance | MPa | 18~25% @0.1MPa | Test with an inlet force of 0.01MPa and a compression rate of 2mm/min |
| | | 30~40% @0.5MPa | |
| | | 45~55% @1.0MPa | |
| Flame retardant performance | | | |
| Flame retardancy | -- | V0 | UL94 |
| Electrical and thermal performance | | | |
| Leakage current | mA | ≤1 | Apply 2700V/mm DC voltage to both ends of the insulation plate for 60 seconds |
| Insulation performance | GΩ | 10 | ASTM D257(1000V DC, 60s) |
| Fire resistance performance | min | 10 | 1000°C Butane flame |
| Thermal conductivity coefficient | W/(m·K) | ≤0.04 | GB/T10295-2008 (25°C) |
| | | 0.055 | GB/T10294-2008 (100°C) |
| | | 0.1 | GB/T10294-2008 (500°C) |
| Long term weather resistance (after packaging) | | | |
| High and low temperature test | -- | pass | 85 °C temperature, 85% humidity, 1000 hours |
| Alternating high and low temperature | -- | pass | The temperature shock range is -40~85 °C, and it is maintained for 30 minutes after reaching each extreme temperature point. The temperature conversion time is based on the fastest time of the equipment. Test 500 cycles. |
| Prohibited and restricted substances | | | |
| ELV | -- | pass | GB/T 30512-2014 |
| RoHS | -- | pass | Requirements of Appendix II to RoHS 2011/65/EU and Revised Directive (EU) 2015/863 |

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SUPHIP—ZK01 Core material testing data



Core material @ 1000 °C Fire Test

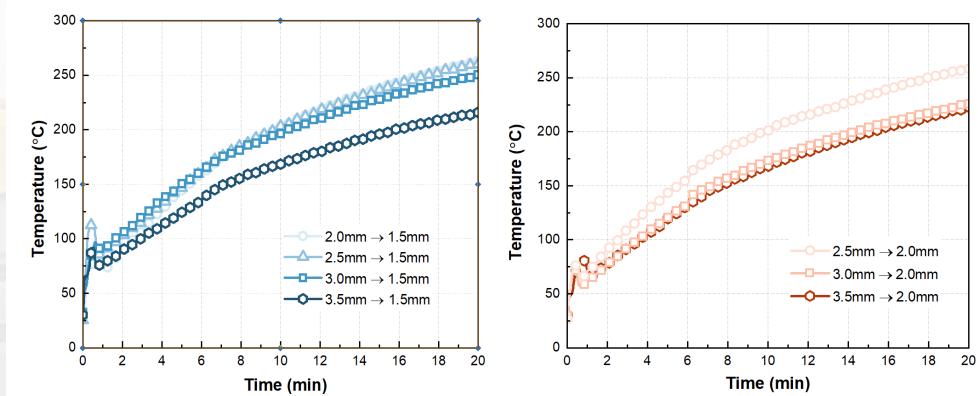


**Core material cold side
temperature @ 1000°C
Fire Test**

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SUPHIP—ZK01 Test data after packaging

High temperature insulation performance test

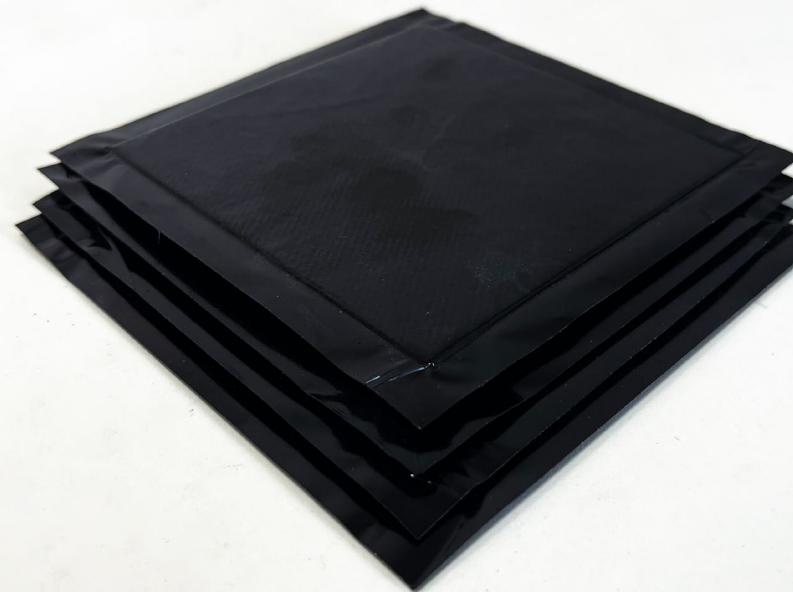


(Typical curve: Cold side temperature under hot surface temperature of 600 °C, 0.9MPa (3min),and 0.03MPa (17min))

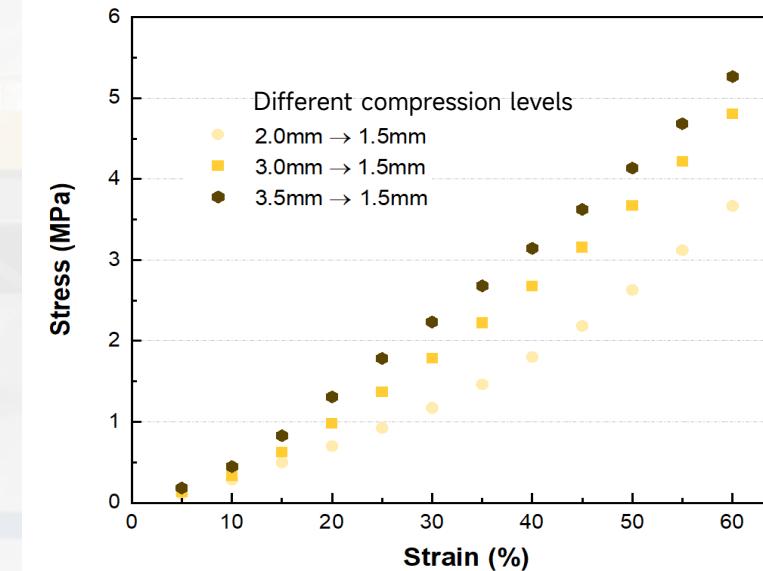
| Samples | 5min | 10min | 15min | 20min |
|---------------|------|-------|-------|-------|
| 2. 0mm→1. 5mm | 144 | 203 | 238 | 263 |
| 2. 5mm→1. 5mm | 146 | 203 | 236 | 260 |
| 3. 0mm→1. 5mm | 150 | 196 | 228 | 251 |
| 3. 5mm→1. 5mm | 124 | 168 | 196 | 216 |
| 2. 5mm→2mm | 143 | 201 | 234 | 258 |
| 3. 0mm→2mm | 121 | 173 | 204 | 226 |
| 3. 5mm→2mm | 119 | 168 | 199 | 223 |
| 4. 0mm→2mm | 129 | 173 | 200 | 219 |

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SUPHIP—ZK01 Compress test data after packaging



SUPHIP—ZK01 Product after packaging



Typical curve: Compression performance after packaging



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Empowering Thermal Runaway Safety Through Material Innovation